

# **CW25-TIM**









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# **Revision History of Version 1.0**

Revision	Date	Released By	Note
1 08/08/05 Rob Rae New version reflecting inter		New version reflecting interfaces performance	
2	07/03/07	Katie Foote	
3	8/20/07	Katie Foote	Testing & Evaluating update

**Table 1 Revision History** 

### **Other Documentation**

The following additional documentation may be of use in understanding this document.

Document	Ву	Note
CW25 User Manual	Navsync	
CW25 Dev Kit User Manual	Navsync	

**Table 2 Additional Documentation List** 



#### 1 INTRODUCTION

The CW25-TIM is a small size GPS OEM module that has been optimized for accurate timing applications. Leveraging Navsync's core CW25 platform that utilizes 12288 correlators in the BB25IC baseband processor to search for low-signal strength GPS signals, the CW25-TIM assumes a positional lock after initially acquiring satellites to optimize GPS timing accuracy. Aside from low signal tracking, which is more applicable for GPS location rather than timing applications, the BB25's algorithms also support quick Time To First Fix (TTFF), when ephemeris and almanac data is available and also in cold start environments. The low signal tracking capabilities have benefits within fixed timing applications by reducing the cost of installations by lessening the burden of high antenna mounts. GPS timing certain will degrade if the GPS antenna is entirely obscured or put indoors, but tracking will continue. Equipment using a CW25-TIM can operate in installations without open-sky access and even some indoor environments.

With a size of just over an inch square (25 x 27 mm) and provided as a tape and reel component, the CW25-TIM is specifically designed to be integrated with Communications devices such as GSM, CDMA, UMTS modems or any other communications medium. The CW25-TIM is optimised for the output of time/ frequency information. Another aid to integration is the ability to store users' software code in the CW25-TIM, reducing the need for external memory and processors.

### Key Features of the CW25-TIM include:

- 25 nsec accuracy to UTC
- Enables indoor use
  - -185 dBW acquisition with network assist
  - -186 dBW tracking
  - -173 dBW acquisition stand alone
- Rapid Time To Fix
  - <2 second outdoors
  - <5 second indoor (-178dBW)
- Standalone CW25-TIM module
  - No GPS knowledge required for hardware integration
- 25 mm x 27 mm x 4.2 mm

This document, the CW25-TIM Data Sheet, provides information on the Hardware Elements of the CW25-TIM.



### Key information includes:

- System Block Diagram
- Maximum Ratings
- Physical Characteristics

CW25-TIM Dimensions, castellation information Solder Pad and placement information

- Signal Descriptions
- Special Features
- Application Information

Power supply modes

RF connections

Grounding

Battery Back-up

Over Voltage and Reverse Polarity

LED's

The specifications in the following sections refer to the standard software builds of the CW25-TIM. The performance and specification of the CW-25TIM can be modified with the use of customized software builds.

# 2 SPECIFICATION 1

### 2.1 Performance

Physical	Module dimensions	25mm (D) x 27mm (W) x 4.2mm (H)
	Supply voltages	3V3 (Digital I/O), 3V3 (RF), 1V8 (Core option), 3V (Standby Battery)
	Operating / Storage Temp	-30°C to +75°C / -30°C to +80°C <sup>2</sup>
	Humidity	5% to 95% non-condensing
	Max Velocity / Altitude	515ms <sup>-1</sup> / 18,000m
	Max Acceleration / Jerk	4g / 1gs <sup>-1</sup> (sustained for less than 5 seconds)
Sensitivity	Acquisition w/network assist	-185dBW
	Tracking	-186dBW
	Aquisition Stand Alone	-173dBW
Acquisition	Hot Start with network assist	Outdoor: <2s
Time		Indoor (-178dBW): <5s
	Stand Alone (Outdoor)	Cold: <45s
		Warm: <38s
		Hot: <5s
		Re-acquisition: <0.5s (90% confidence)
Accuracy	Position: Outdoor / Indoor	<5m rms / <50m rms
	Velocity	<0.05ms <sup>-1</sup>
	Latency	<200ms
	Raw Measurement Accuracy	Pseudorange < 0.3m rms, Carrier phase < 5mm rms
	Tracking	Code and carrier coherent
Power	1 fix per second	0.6W typically
	Coma Mode Current	10mA
	(RF3V3+DIG 3V3)	
	Standby Current (VBATT)	1.5μΑ
Interfaces	Serial	3 UART ports, CMOS levels
	Multi-function I/O	1PPS Frequency Output available on GPIO [0]
		Event Counter/Timer Input
		Up to 4 x GPIO (multi-function)
		2 x LED Status Drive
		I <sup>2</sup> C, External Clock (on special build)
	Protocols	Network Assist, NMEA 0183, Proprietary ASCII and
		binary message formats
	1pps Timing Output	30ns rms accuracy, <5ns resolution
		User selectable pulse width
	Event Input	30ns rms accuracy, <10ns resolution
	Frequency Output (GPIO [0])	10 Hz to 30 MHz (CW25-TIM)
	Receiver Type	12 parallel channel x 32 taps up to 32 point FFT.
		Channels, taps and FFT can be switched off to
		minimize power or simulate simpler designs.
General	Processor	ARM 966E-S on a 0.18µ process at up to 120 MHz.

Note: 1. The features listed above may require specific software builds and may not all be available in the initial release.

# Table 3 CW25-TIM Specification



<sup>2.</sup> Please contact factory for other temperature options.

### 2.2 Recommended Ratings

Symbol	Parameter	Min	Max	Units
RF_3V3	RF Supply Voltage	+3.0	+3.6	Volts
DIG_3V3	Digital Supply Voltage	+3.0	+3.6	Volts
DIG_1V8	Digital Supply Voltage	+1.65	+1.95	Volts
VBATT	Battery Backup Voltage	+2.7	+3.5	Volts
ANT_SUPPLY	Antenna Supply Voltage	+3.0	+12	Volts

Table 4 Recommended Maximum Ratings

### 2.3 Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Units
RF_3V3	RF Supply Voltage	-0.3	+6.5	Volts
DIG_1V8	Digital Supply Voltage	-0.3	+2.0	Volts
DIG_3V3	Digital Supply Voltage	-0.3	+3.7	Volts
VBATT	Battery Backup Voltage	-0.5	+7.0	Volts
ANT_SUPPLY	Antenna Supply Voltage	-15	+15	Volts
DIG_SIG_IN	Any Digital Input Signal	-0.3	+5.5	Volts
RF_IN	RF Input	-15	+15	Volts
TSTORE	Storage temperature	-30	+80	°C
IOUT	Digital Signal Output Current	-6	+6	mA

Table 5 Absolute Maximum Ratings

### 2.4 Block Diagram

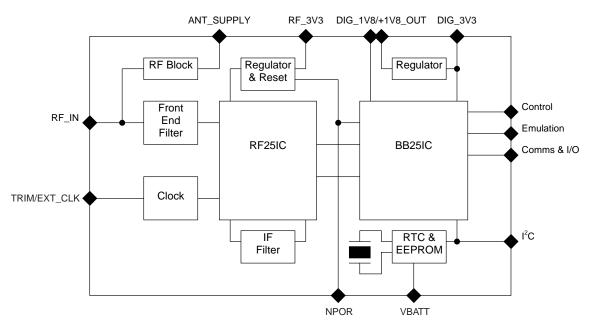


Figure 1 CW25-TIM Block Diagram

### **3 PHYSICAL CHARACTERISTICS**

The CW25-TIM is a multi-chip module (MCM) built on an FR4 fibreglass PCB. All digital and power connections to the CW25-TIM are via castellations on the 25 x 27 mm PCB. The RF connection is via castellations or an RF connector. The general arrangement of the CW25-TIM is shown in the diagram below. Dimensions in mm (inches/1000).

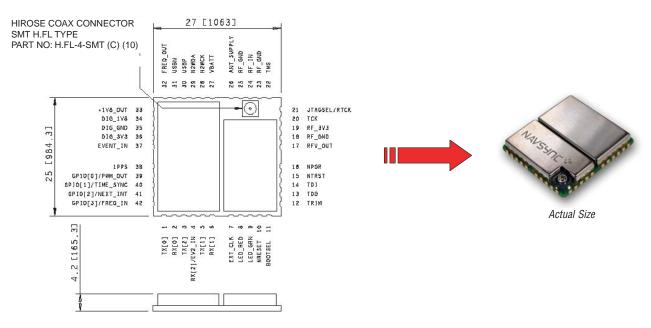


Figure 2 CW25-TIM Form and Size

### 3.1 Physical Interface Details

The interface to the CW25-TIM is via 1mm castellations on a 2mm pitch. There are 42 connections in all. There is also an RF connector for connecting to the GPS antenna. The details of the interface connections are given below.

Pin	Function	Pin	Function	Pin	Function	
1	TX[0]	15	NTRST	29	N2WDA	
2	RX[0]	16	NPOR	30	USBP	
3	TX[2]	17	RFV_OUT	31	USBN	
4	RX[2]/EV2_IN	18	RF_GND	32	FREQ_OUT	
5	TX[1]	19	RF_3V3	33	+1V8_OUT	
6	RX[1]	20	TCK	34	DIG_1V8	
7	EXT_CLK	21	JTAGSEL/RTCK	35	DIG_GND	
8	LED_RED	22	TMS	36	DIG_3V3	
9	LED_GRN	23	RF_GND	37	EVENT_IN	
10	NRESET	24	RF_IN	38	1PPS	
11	BOOTSEL	25	RF_GND	39	GPIO[0]/PWM_OUT <sup>3</sup>	
12	TRIM	26	ANT_SUPPLY	40	GPIO[1]/TIME_SYNC	
13	TDO	27	VBATT	41	GPIO[2]/NEXT_INT	
14	TDI	28	N2WCK	42	GPIO[3]/FREQ_IN	
N-4 O	Nets 0. The 10 He to 00 MHz fragger outside a scient a scient as a fig. 00 (ODIO)01 / DIAM OUT) and not as EDEO OUT					

Note: 3. The 10 Hz to 30 MHz frequency output is available on pin 39 (GPIO[0] / PWM\_OUT) and not on FREQ\_OUT.

Table 6 CW25-TIM Signal List

#### 3.2 CW25-TIM Dimensions

The figure below provides the dimensions of the positioning of the CW25-TIM castellations. Dimensions in mm (inches/1000).

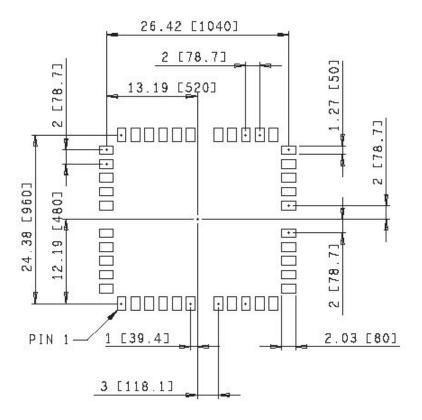


Figure 3 CW25-TIM Dimensions

#### 3.3 Solder Pad Size and Placement

It is recommended that the footprint of the solder pad under each castellation be 2mm x 1mm, centred on the nominal centre point of the radius of the castellation. The castellations are gold plated and so are lead free. Note that if the RF\_IN connector is being used, there should not be a pad or solder resist under the RF\_IN castellation. If the RF\_IN castellation is to be used, the pad should be shortened by 0.5mm underneath the CW25-TIM and standard RF design practices must be observed. The diagram below shows the placement of the pads under the castellations.



Figure 4 Solder Pad Size and Placement



# **4 SIGNAL DESCRIPTION**

The signals on the CW25-TIM are described in the table below.

# 4.1 Power Signals

RF_3V3	Type: Power	Direction: Input	Pin: 19		
	the RF section of t	ut. This $3.3V \pm 10\%$ input suppl he CW25-TIM. It is important th 50mV peak to peak noise with re	at this supply is well filtered		
RF_GND	Type: Power	Direction: Input/Output	Pins: 18, 23, 25		
		nd. This is the return path for the enna feed. The RF_GND must bw25-TIM.			
RFV_OUT	Type: Power	Direction: Output	Pin: 17		
	supplies the powe used to power extensive onto this sig	re LDO regulator that is powered r to the RF subsystem of the CV ernal RF components but care n nal. No more than an additional rnal circuitry. ANT_SUPPLY	V25-TIM. This may also be nust be taken not to inject		
Type: Power	Direction: Input	Pin: 26			
	signal, for use by a	y voltage. This may be used to an active antenna. The maximur ent should be limited to 50mA.			
DIG_3V3	Type: Power	Direction: Input	Pin: 36		
	The digital supply input. This $3.3V \pm 10\%$ input supplies the I/O ring of the BB25IC chip and the LDO regulator in the digital section of the CW25-TIM. It is important that this supply is well filtered with no more that 50mV peak to peak noise with respect to DIG_GND.				
DIG_1V8	Type: Power	Direction: Input	Pin: 34		
	directly to the +1V	ital core supply for the BB25IC. 8_OUT signal. However, if an extem power consumption may be	sternal 1.8V $\pm$ 5% is available,		
+1V8_OUT	Type: Power	Direction: Output	Pin: 33		
	Normally, this is con external logic but c	m the LDO regulator that is powe nnected to the DIG_1V8 signal. T are must be taken not to inject no 50mA may be taken from this sign	his may also be used to power ise onto this signal. No more		
DIG_GND	Type: Power	Direction: Input/Output	Pin: 35		
	ground reference f	This is the return path for the Eor all the digital I/O. The DIG_Gy to the CW25-TIM.			



### 4.1 Power Signals cont'd

VBATT	Type: Power	Direction: Input/Output	Pin: 27
	(RTC). This is pow than 2.5V and les can be left floating rechargeable batt resister in series v	up supply. The CW25-TIM has vered from the VBATT signal. As than DIG_3V3) should be apping if not required. The input has teries will need an external charwith this signal and the external ring the current consumption from	supply of typically 3v (greater lied to this signal. This signal a blocking diode and so ging circuit. Typically, a 1K battery will provide an easy
4.2 RF Signals			
RF_IN	Type: RF	Direction: Input	Pin: 24
	connection to the the RF connector made. If the RF c	ed when tracking to this signal. ANT_SUPPLY signal. This is to on the CW25-TIM. Only one acconnector is to be used, then the cted pad, to this castellation.	the same signal presented on ntenna connection should be
TRIM	Type: RF	Direction: Input	Pin: 12
	left open. When f	the output frequency of the VCT floating, this signal is biased to bise injected into this signal will be CW25-TIM. This signal shou ication notes.	the control voltage of the severely compromise the
EXT_CLK	Type: RF	Direction: Input	Pin: 7
	•	ully has no internal connection in	•

builds of the CW25-TIM that are not fitted with an internal VCTCXO, this input is the external clock input. The external clock is a 9MHz to 26MHz clipped sign wave input with an amplitude between 1V and 3V peak to peak. The return path for this signal is RF\_GND.

### 4.3 Emulation/Test Signals

TDI	Type: Test	Direction: Input	Pin: 14
	The Test Data In s	signal. This is the standard JTA	G test data input. The signal
TDO	Type: Test	Direction: Output	Pin: 13

The Test Data Out signal. This is the standard JTAG test data output. The signal return path is DIG\_GND.



# 4.3 Power Signals cont'd

TCK	Type: Test	Direction: Input	Pin: 20			
	The Test Clock si return path is DIC	gnal. This is the standard JTA $_{ m G}$ GND.	G test clock input. The signal			
TMS	Type: Test	Direction: Input	Pin: 22			
		The Test Mode Select signal. This is the standard JTAG test mode input. The signal return path is DIG_GND.				
JTAGSEL/RTCK	Type: Test	Direction: Input/Outpu	ıt Pin: 21			
	signal is an input JTAG emulation i the BB25IC chip latched when NP and the JTAG em clock to the ARM domain, the TCK cause a variable synchronised ver	(3)	e JTAG interface. When high, essor is selected. When low, ed. The value on this signal is hen NPOR is de-asserted (high) d, this signal provides the return functions off a single clock sed in the ARM9. This can he TDO signal. The RTCK is a ulti-ICE uses the RTCK output			
NTRST	Type: Test	Direction: Input	Pin: 15			
	The Test Reset si return path is DIG	•	AG test reset signal. The signal			

# 4.4 Control Signals

NPOR	Type: Control	Direction: Input/Output	Pin: 16
	reset for the CW25- signal. The signal o	et signal. This active low, open of TIM. The CW25-TIM can be he can be used to reset external circ DC current is drawn from this sig	ld in reset by asserting this cuitry, but care must be
NDECET	T O t l	Discretions Investigation	Di 40
NRESET	Type: Control	Direction: Input/Output	Pin: 10
	The system reset signal. This active low, open collector signal is generated by the BB25IC chip in response to the assertion of the NPOR. It may also be driven to reset the ARM9 processor in the BB25IC without completely reinitialising the chip.		
BOOTSEL	Type: Control	Direction: Input	Pin: 11
	supported by the C' asserted. If the BO boots from its on-ch	nal. The BB25IC has four boot uW25-TIM. This signal is sample OTSEL signal is high or left float hip FLASH memory. If the BOOT om its on-chip ROM.	d when the NPOR is de- ting, then the CW25-TIM



# 4.5 I/O Signals

TX[0]	Type: I/O	Direction: Output	Pin: 1	
	The transmit signal signal return path	al for UART 0. This is a standard is DIG_GND.	UART output signal. The	
TX[1]	Type: I/O	Direction: Output	Pin: 5	
	The transmit signal return path	al for UART 1. This is a standard is DIG_GND.	UART output signal. The	
TX[2]	Type: I/O	Direction: Output	Pin: 3	
	The transmit signal for UART 2. This is a standard UART output signal. The signal return path is DIG_GND.			
RX[0]	Type: I/O	Direction: Input	Pin: 2	
_	The receive signal for UART 0. This is a standard UART input signal. The signal return path is DIG_GND.			
RX[1]	Type: I/O	Direction: Input	Pin: 6	
	The receive signal for UART 1. This is a standard UART input signal. The signal return path is DIG_GND.			
RX[2]/EV2_IN	Type: I/O	Direction: Input	Pin: 4	
	This is a dual mode signal. Normally, this is the receive signal for UART 2, a standard UART receive signal. Under software control, it can also be used as general purpose I/O or to detect events. It can be used to detect the timing of the leading edge of the start bit of the incoming data stream. The signal return path is DIG_GND.			
FREQ_OUT	Type: I/O	Direction: Input/Output	Pin: 32	
	Optional frequency output signal. This is NOT the same signal as pin 30. This signal is turned off by default. This is a complex signal which under software can provide any of either an NCO generated output frequency, a PWM signal, a GPS aligned EPOCH pulse or general purpose I/O signal. The signal return path is DIG_GND.			
1PPS	Type: I/O	Direction: Input/Output	Pin: 38	
	The 1 pulse per second signal. This is normally a 1 pulse aligned with GPS time, but can under software control also provide general purpose I/O or an additional even input. The pulse width of the 1PPS is software selectable with a default of 100µs. The signal return path is DIG_GND.			
EVENT_IN	Type: I/O	Direction: Input/Output	Pin: 37	
	timed against GPS external 48MHz ir	gnal. This is normally an event t S time. Under software control, aput for the USB interface or this O. The signal return path is DIG	this input can be used as an input can also be used for	

# 4.5 I/O Signals cont'd

N2WCK	Type: I/O	Direction: Input/Output	Pin: 28
	•	Vire Clock signal. This is the open the 2 wire serial interface. The sign	·
N2WDA	Type: I/O	Direction: Input/Output	Pin: 29
	•	Vire Data signal. This is the open over the serial interface. The signal returns	•
USBP <sup>4</sup>	Type: I/O	Direction: Input/Output	Pin: 30
	The positive USB signal. The signal return path is DIG_GND.		
USBN <sup>4</sup>	Type: I/O	Direction: Input/Output	Pin: 31
	The negative US	B signal. The signal return path is	DIG_GND.
LED_RED	Type: I/O	Direction: Output	Pin: 8
	This is a dual function signal. Normally this signal is used to drive a red LED. Standard software builds use this signal to indicate GPS status. In special software builds, this signal can be used as GPIO. This signal has a 3.3V CMOS drive. A series limiting resistor is required to limit output current to ±5mA. The signal return path is DIG_GND.		
LED_GRN	Type: I/O	Direction: Output	Pin: 9
	This is a dual function signal. Normally this signal is used to drive a green LED. Standard software builds use this signal to indicate GPS status. In special software builds, this signal can be used as GPIO. This signal has a 3.3V CMOS drive. A series limiting resistor is required to limit output current to ±5mA. The signal return path is DIG_GND.		
GPIO[0]/PWM	Type: I/O	Direction: Input/Output	Pin: 39
	The GPIO[0] signal. This is the default Frequency Output pin. Primarily for general purpose I/O, this signal can also be programmed to provide either a frequency, PWM or EPOCH output. Defaults to 10 MHz, Maximum is 30 MHz. The output is always enabled. It can also be configured to form and external RC oscillator in combination with GPIO[3]. The signal return path is DIG_GND.		
GPIO[1]/TIME_SYNC	Type: I/ODirecti	on: Input/Output	Pin: 40
	The GPIO[1] signal. Primarily for general purpose I/O, this signal can also be programmed to provide either an additional PPS output or a time synchronisation input to the GPS engine in the BB25IC chip. The synchronisation pulse can be provided from an external source or can be generated by the on-board RTC. When generated by the onboard RTC, the synchronisation signal can be observed on this pin signal. The signal return path is DIG_GND.		

Note: 4. USB is not supported in the current software build.



### 4.5 I/O Signals cont'd

GPIO[2]/NEXT_INT	Type: I/O	Direction: Input/Output	Pin: 41
	The GPIO[2] signal. Primarily for general purpose I/O, this signal can also be programmed to provide an interrupt event from an active low external input. The signal return path is DIG_GND.		
GPIO[3]/FREQ_IN	Type: I/O	Direction: Input/Output	Pin: 42
	The GPIO[3] signal. Primarily for general purpose I/O, this signal can also be programmed to provide a frequency counter input. The frequency counter input has a Schmitt trigger and if used with GPIO[0] can be configured to form a temperature controlled oscillator. The signal return path is DIG_GND.		

### **5 SPECIAL FEATURES**

While most of the features on the CW25-TIM are just a subset of the capabilities of the CW25 and so are described in the CW25 Data Sheet and the CW25 User Manual, there are some additional features buried in the CW25-TIM that need specific explanation, especially if use is to be made of them by user application code.

#### 5.1 Power on Reset

The power on reset for the CW25-TIM is generated on-board by the regulator in the RF section from the RF\_3V3 signal. The RF\_3V3 signal must be applied to the CW25-TIM at the same time as the DIG\_3V3, if the on-board power on reset is to be used. If an external source of reset is to be applied to the NPOR signal after both the RF\_3V3 and the DIG\_3V3 signals are valid, this restriction does not apply.

#### 5.2 Time Transfer

In order to aid time transfer between fixes during which the CW25-TIM has been unable to maintain an accurate perception of time (eg. in deep sleep or powered down states), the on-board RTC can be set to provide a signal derived from the 32.768Hz crystal.

#### 5.3 CW25-TIM Embedded Identification

The hardware version number is hard coded onto the CW25-TIM; firmware also contains a version number allowing for easy identification of the hardware and software version in embedded applications.

#### 5.4 User Commands

The CW25-TIM can accept a number of specific user commands that can be used to set receiver parameters such as UART baud rate and message subset. NCO frequency, 1 pps initialization etc. These commands are defined in detail within the CW25 User Manual and the set values are stored in Non-Volatile Memory (NVM) within the CW25-TIM receiver.



#### **6 APPLICATION HINTS**

The following are a list of application hints that may help in implementing system based on the CW25-TIM.

### 6.1 Power Supply

The power supply requirements of the CW25-TIM can all be provided from a single 3.3V supply. To simplify system integration on-board regulators provide the correct voltage levels for the RF and oscillator (2.9V or 3.0V) and low voltage digital core (1.8V). In power sensitive applications it is recommended that the DIG\_1V8 supply is provided from a high efficiency external 1.8V source e.g. switch mode power supply, rather than the on-board linear regulator.

If the source impedance of the power supply to the CW25-TIM is high due to long tracks, filtering or other causes, local decoupling of the supply signals may be necessary. Care should be taken to ensure that the maximum supply ripple at the pins of the CW25-TIM is 50mV peak to peak.

#### 6.2 RF Connection

The RF connection to the CW25-TIM can be done in two ways. The preferred method is to use standard microstrip design techniques to track from the antenna element to the RF\_IN castellation,. This also allows the systems integrator the option of designing in external connectors suitable for the application. The user can easily fit an externally mounted MCX, SMA or similar connector, provided it is placed adjacent to the RF IN castellation. If the tracking guidelines given below are followed, the impedance match will be acceptable. The diagram below shows how this could be achieved. In this diagram, the centre via of the RF connector is presumed to be plated through with a minimal pad top and bottom. The PCB material is assumed to be 1.6mm thick FR4 with a dielectric constant of 4.3. Two situations are considered; one with no ground plane and one with a ground plane on the bottom of the board, underneath the RF connector. In both cases there is no inner layer tracking under the RF connector.

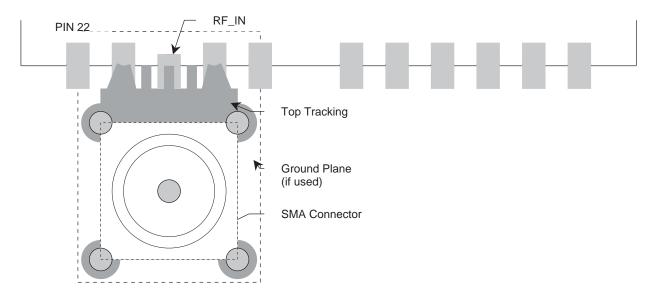


Figure 5 RF Tracking Example

The widths of the RF\_IN track and the associated gaps are given in the table below.

Scenario	Track Width (1/1000 Inch)	Gap Width (1/1000 Inch)	
Without ground plane	37	6	
	56	8	
With ground plane	32	6	
	43	8	

Table 7 RF Track & Gap Widths

Alternatively, the user can attach the antenna to the Hirose H.FL-R-SMT using a flying lead fitted with a suitable plug.

#### 6.3 Grounding

In connecting the CW25-TIM into a host system, good grounding practices should be observed. Specifically, ground currents from the rest of the system hosting the CW25-TIM should not pass through the ground connections to the CW25-TIM. This is most easily ensured by using a single point attachment for the ground. There must also be a good connection between the RF\_GND and the DIG\_GND signals. Whilst there is not a specific need to put a ground plane under the CW25-TIM, high energy signals should not be tracked under the CW25-TIM. It is however recommended that a ground plane be used under the CW25-TIM. In this case, the following would be an example of the pattern that may be used

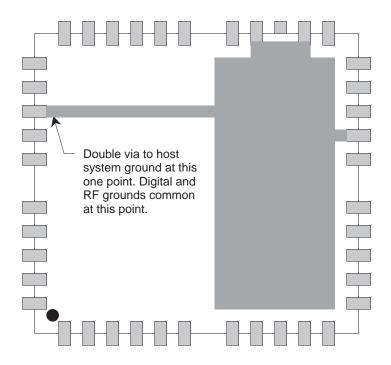


Figure 6 Grounding the CW25-TIM with a Ground Plane

### 7 Battery Backup

The CW25-TIM has an on-board real time clock (RTC). This is used to store date and time information whilst the CW25-TIM is powered down. Having a valid date and time speeds the time to first fix (TTFF), allowing the CW25-TIM to meet its quoted TTFF specification. The CW25-TIM relies on an external power source to power the RTC (VBATT) when the DIG\_3V3 is not present. If the user application does not require the warm or hot fix performance, or the required information is provided by network assistance, there is no need to provide the VBATT signal. The VBATT signal must be greater than 2.6V and less than DIG 3V3 + 0.6V. Typically, a 3V lithium primary cell or a high capacity "supercap" will be used. The CW25-TIM has an internal blocking diode, so if a "supercap" or rechargeable battery is used, an external charging circuit will be required.

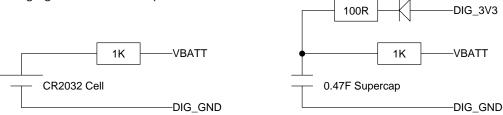


Figure 7 Typical VBATT Supplies

The 1K resistor is recommended at it limits current in the VBATT circuit and provides an easy way to measure the current in the VBATT signal. The 100R limits the inrush current into the "supercap".

### 7.1 Over Voltage & Reverse Polarity Protection

The CW25-TIM contains no over voltage or reverse polarity protection. The CW25-TIM should be handled as a CMOS component, with full antistatic handling precautions. Any fault condition that results in the maximum limits being exceeded may irreparably damage the CW25-TIM.

#### **7.2 LEDs**

There are two connections on the CW25-TIM specifically intended to drive status LEDs. The LED\_RED and LED GRN signals should be connected, via suitable current limiting resistors, to the anodes of low current LEDs whose cathodes are connected to DIG\_GND. The outputs are standard 3.3V CMOS and the current drawn should be limited to 5mA per output. Using a 270 ohm resistor provides a suitable current limit. If appropriately coloured LEDs are attached to these signals, other documentation (eg. CW25 user manuals) that refers to these status LEDs will be correct. If LEDs are not required, these signals can be left open. These signals may be connected to other logic if required.

#### 7.3 Reset Generation

The power on reset for the CW25-TIM is generated on-board. It is generated by the regulator for the RF section. This signal is an active low, open collector signal and is presented on the NPOR castellation. If it is desired to extend the power on reset signal or provide a manual reset for the CW25-TIM, this signal can be driven from an open collector source at any time. The nPOR signal of the BB25IC, to which the NPOR castellation is connected. has a Schmitt trigger input. This means that there are no constraints on the rise time of the NPOR signal.

There is a second reset signal on the CW25-TIM, the NRESET signal. NRESET is also an active low open collector signal. This signal is generated by the BB25IC in response to the NPOR signal. It can also be generated under software control. Asserting the NRESET signal from an external open collector source will reset the ARM9 in the BB25IC without resetting the whole chip. Generally, this signal will be left open.

#### 7.4 Boot Options

The CW25-TIM has two boot modes. These are selected by the state of the BOOTSEL signal when the NPOR signal goes inactive (high). Normally, BOOTSEL is left open so that a pull-up bias in the BB25IC will keep that signal high. When BOOTSEL is high, the CW25-TIM boots from the FLASH that is internal to the BB25IC. If BOOTSEL is tied low, the CW25-TIM boots from the ROM internal to the BB25IC. This ROM has a boot loader that polls the serial ports and I<sup>2</sup>C bus for boot code. This mode of operation requires special user handling and should only be used in conjunction with specific application notes.





# **CW25-TIM**



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